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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/758,321	01/12/2001		Norimasa Niiya	04329.2495	9116
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FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER LLP				EXAMINER	
				TAYLOR, BARRY W	
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WASHINGT	ON, DC	20003		ART UNIT	PAPER NUMBER
				2643	1
				DATE MAILED: 09/05/2002	0

Please find below and/or attached an Office communication concerning this application or proceeding.

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·	Application No.	Applicant(s)					
4	09/758,321	NIIYA, NORIMASA					
Office Action Summary	Examiner	Art Unit					
	Barry W Taylor	2643					
The MAILING DATE of this communication app Period for Reply	ears on the cover shee	with the correspondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1: after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	36(a). In no event, however, ma y within the statutory minimum of vill apply and will expire SIX (6) No., cause the application to becom	y a reply be timely filed thirty (30) days will be considered timely. MONTHS from the mailing date of this communication (35 U.S.C. § 133).	ion.				
1) Responsive to communication(s) filed on	_						
<u> </u>	— · is action is non-final.						
3) Since this application is in condition for alloward closed in accordance with the practice under	ance except for formal i		s is				
Disposition of Claims							
4)⊠ Claim(s) <u>1-14</u> is/are pending in the application							
4a) Of the above claim(s) is/are withdraw	vn from consideration.						
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-14</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and/or	r election requirement.						
Application Papers9)☐ The specification is objected to by the Examine.	_						
10) The drawing(s) filed on is/are: a) accept		y the Eveniner					
Applicant may not request that any objection to the							
11) The proposed drawing correction filed on							
If approved, corrected drawings are required in rep		disapproved by the Examiner.					
12) The oath or declaration is objected to by the Ex	•						
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign	priority under 35 U.S.	C. § 119(a)-(d) or (f).					
a) ☐ All b) ☐ Some * c) ☐ None of:	, , ,						
1. Certified copies of the priority documents	s have been received.						
2. Certified copies of the priority documents		Application No.					
Copies of the certified copies of the prior application from the International But See the attached detailed Office action for a list.	ity documents have be reau (PCT Rule 17.2(a	en received in this National Stage					
14) Acknowledgment is made of a claim for domestic	priority under 35 U.S.	C. § 119(e) (to a provisional applica	tion).				
 a) ☐ The translation of the foreign language pro 15)☐ Acknowledgment is made of a claim for domesti 							
Attachment(s)		•					
1) X Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 4.	5) Notice	ew Summary (PTO-413) Paper No(s) of Informal Patent Application (PTO-152)					

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DETAILED ACTION

Claim Rejections - 35 USC § 103

1. Claims 1-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Mano et al (5,319,700 hereinafter Mano) in view of Best et al (6,005,846 hereinafter Best).

Regarding claims 1, 5, 9-10, 12 and 14. Mano teaches a an interface unit (9,11, 13, 15, 17 and 19 figure 1, col. 3 lines 1-25) capable of being connected to a main unit of a key telephone system (1 figure 1), the main unit connecting a telephone terminal (27 figure 1) to a telephone network (25 figure 1), the interface unit being adapted to be communicated with the telephone terminal at one of plural transmission speeds (col. 1 lines 13-65, see figure 4 wherein "PING-PONG" communications is employed by using the D-Channel to select "low level" or "high level"--column 6 line 66+), the interface unit comprising:

Mano does not explicitly show using a query signal to determine the type of communication speed required for communication and changing the transmission speed based upon the type of communication speed required.

Best teaches and an apparatus for an improved ISDN terminal adaptor having automatic service profile identifier (a.k.a. SPID) configuration so that the subscriber does not have to manually enter the SPID provided by the subscribers telephone company (columns 1-2). Best also discloses "autobaud" capability as well as eliminating baud rate blocking that occurs when a subscriber using a conventional ISDN terminal (i.e. low baud rate) moves the adapter to a different computer. In other words,

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when a subscriber moves a conventional ISDN terminal that was preset either by the factory or the subscriber to a predefined baud rate, the terminal adaptor and computer will not communicate until baud rates match (columns 1-4). Best overcomes the problems associated with conventional ISDN terminals by using the D-channel to indicate baud type and message responses (col. 4 line 20 – col. 5 line 15, col. 15 lines 37-67, col. 16 lines 1-3, col. 17 lines 8-67, col. 18 line 59 – 30 line 47). More specifically, the inventive terminal adaptor automatically detects the type of ISDN switch to which the adaptor is and configures the SPID correctly for that particular switch, provides both baud rate unblocking and automatic data compression (columns 1-14).

Therefore, it would have been obvious for any one of ordinary skill in the art at the time the invention was made to modify the invention as taught by Mano to use an improved adaptor using the D-channel for "autobaud" capability as taught by Best for the benefit of automatically setting transmission rate.

Regarding claims 2-4, 6-8. Mano does not disclose the second speed is faster than the first speed, the plural transmission speeds includes at least two speeds, or the second transmitter transmits the speed change request.

Best teaches and an apparatus for an improved ISDN terminal adaptor having automatic service profile identifier (a.k.a. SPID) configuration so that the subscriber does not have to manually enter the SPID provided by the subscribers telephone company (columns 1-2). Best also discloses "autobaud" capability as well as eliminating baud rate blocking that occurs when a subscriber using a conventional ISDN terminal (i.e. low baud rate) moves the adapter to a different computer. In other words,

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Therefore, it would have been obvious for any one of ordinary skill in the art at the time the invention was made to modify the invention as taught by Mano to use an improved adaptor using the D-channel for "autobaud" capability as taught by Best for the benefit of automatically setting transmission rate.

Regarding claims 11 and 13. Mano does not disclose causing the telephone terminal set an operation speed to the optimum speed based on the detected result of the detector.

Best teaches and an apparatus for an improved ISDN terminal adaptor having automatic service profile identifier (a.k.a. SPID) configuration so that the subscriber does not have to manually enter the SPID provided by the subscribers telephone company (columns 1-2). Best also discloses "autobaud" capability as well as eliminating baud rate blocking that occurs when a subscriber using a conventional ISDN terminal (i.e. low baud rate) moves the adapter to a different computer. In other words,

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when a subscriber moves a conventional ISDN terminal that was preset either by the factory or the subscriber to a predefined baud rate, the terminal adaptor and computer will not communicate until baud rates match (columns 1-4). Best overcomes the problems associated with conventional ISDN terminals by using the D-channel to indicate baud type and message responses (col. 4 line 20 – col. 5 line 15, col. 15 lines 37-67, col. 16 lines 1-3, col. 17 lines 8-67, col. 18 line 59 – 30 line 47). More specifically, the inventive terminal adaptor automatically detects the type of ISDN switch to which the adaptor is and configures the SPID correctly for that particular switch, provides both baud rate unblocking and automatic data compression (columns 1-14).

Therefore, it would have been obvious for any one of ordinary skill in the art at the time the invention was made to modify the invention as taught by Mano to use an improved adaptor using the D-channel for "autobaud" capability as taught by Best for the benefit of automatically setting transmission rate.

Conclusion

- 2. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.
- ---(6,424,636) Seazholtz et al is considered pertinent for **having similar independent claims** (see all independent claims starting on column 17).
- ---(6,195,359) Eng et al is considered pertinent for using new modems **instead**of legacy devices communicating at slower speeds. In other words, Eng et al also

 uses querying/response signals (via D-channel call control) to determine optimum

 transmission speed.

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---(5,491,720) Davis et al is considered pertinent and was cited by Eng et al (6,195,359 listed directly above).

---(5,943,364) Yoshida is considered pertinent for setting transmission rates based on send and received messages.

---(6,389,065) McGhee is considered pertinent for an adaptive rate communication system wherein if the date rate is optimal, then, the equipment continues to operate at the current data rate. Otherwise, it can be determined what change should be made (i.e. move to higher or lower baud rate).

3. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Barry W. Taylor whose telephone number is (703) 305-4811. The examiner can normally be reached on Monday-Friday from 6:30am to 4pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Curtis Kuntz can be reached on (703) 305-4708. The fax phone number for this Group is (703) 872-9314.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to Technology Center 2600 customer service Office whose telephone number is (703) 306-0377.

STELLA WOO
PRIMARY EXAMINER

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Appellant further observes that the function of maximizing the breakdown voltage as disclosed by Dennen is directed to the tub structure disclosed by Dennen. For example, Dennen teaches that the source and drain regions 123 and 124 can be made shallow enough to allow a region of low concentration N silicon to exist above the junction between the tub 122 and well 123 (*see*, *e.g.*, Dennen's Fig. 9 reproduced below, along with Col. 26:38-41). In contrast, the Hueting device does not have a structure that corresponds to Dennen's tub 122. As such, the Examiner has not demonstrated that Hueting '348 would benefit from the teachings of Dennen as asserted (*i.e.*, that the proposed combination would maximize the breakdown voltage of Hueting '348).

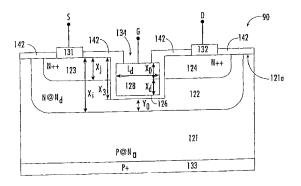


Figure 9 Dennen

In light of the above discussions, it is unclear to Appellant how the Examiner is proposing to combine the teachings of Hueting '348 with Dennen, and the Examiner has not provided any detail. For example, the Examiner has not specified where the shallow contact regions are to be incorporated into the Hueting device, or whether or how Dennen's tub region 122 is to be incorporated into the Hueting device. The Examiner has merely stated that, regardless of whether or not Hueting's device has a structure that corresponds to Dennen's tub, Hueting's device can still benefit from a conductive shallow contact region to maximize the breakdown voltage (*see, e.g.*, Advisory Action). However, the Examiner has not provided any evidence as to how the proposed combination would maximize the breakdown voltage of Hueting '348 without Dennen's tub structure and corresponding functionality.

Appellant submits that the statements made by the Examiner amount to no more than conclusory statements of generalized advantages and convenient assumptions about

skilled artisans. Such statements and assumptions are inadequate to support a finding of motivation, which is a factual question that cannot be resolved on subjective belief and unknown authority. Thus, the Examiner relies upon improper conclusory statements in asserting obviousness, thereby directly contradicting M.P.E.P. § 2142 which states that "rejections on obviousness cannot be sustained with mere conclusory statements; instead, there must be some articulated reasoning with some rational underpinning to support the legal conclusion of obviousness." *See, also KSR Int'l Co. v. Teleflex Inc.*, 127 S. Ct. 1727, 1741 (U.S. 2007).

For at least these reasons, Appellant submits that the Hueting '348 and Dennen references are not combinable in the manner proposed, and that insufficient reason to combine has been provided by the Examiner. Accordingly, the § 103(a) rejection of claims 1-3 and 5-10 is improper, and Appellant requests that it be reversed.

B. The § 103(a) rejection of claim 4 over Hueting '348 in view of Dennen and further in view of Hueting '823 is improper and should be reversed.

Appellant respectfully submits that the Hueting '823 reference provides no teaching or disclosure to overcome the underlying deficiencies set forth above with respect to the proposed combination of Hueting '348 with Dennen. In at least this regard, the § 103(a) rejection of claim 4 is improper, and Appellant requests that it be reversed.

VIII. Conclusion

In view of the above, Appellant submits that the rejections of claims 1-10 are improper. Appellant therefore requests reversal of the rejections as applied to the appealed claims and allowance of the entire application.

Authority to charge the undersigned's deposit account was provided on the first page of this brief.

Please direct all correspondence to:

Corporate Patent Counsel NXP Intellectual Property & Standards 1109 McKay Drive; Mail Stop SJ41 San Jose, CA 95131

CUSTOMER NO. 65913

Respectfully Submitted,

Name: Robert V. Crawford

Reg. No.: 32,122 Robert J. Pechman Reg. No.: 45,002

Tel: 651 686-6633 ext. 2300

(NXPS.323PA)

APPENDIX OF CLAIMS INVOLVED IN THE APPEAL (S/N 10/562,254)

1. A semiconductor device having opposed first and second major surfaces, comprising:

a body region at the first major surface;

at least one cell having longitudinally spaced source and drain implantations extending into the body region from the first major surface, the source and drain implantations being spaced away from the substrate by part of the body region and defining a channel part of the body region between the source and drain implantations; and

at least one insulated gate trench extending longitudinally from the source implantation to the drain implantation through the body region, the insulated gate trench including a gate conductor insulated from the source and drain implantations and the body region by a gate dielectric along the side and end walls and the base of the trench, the source and drain implantations extending along part of the side walls of the trench,

wherein the source and drain implantations include conductive shallow contact regions at the first major surface extending vertically into the body to a depth of no more than 35% of the depth of the trench.

- 2. A semiconductor device according to claim 1 wherein the body region is of first conductivity type and the shallow contact regions are of a second conductivity type opposite to the first conductivity type.
- 3. A semiconductor device according to claim 1 or 2 wherein each of the source and drain implantations further comprises a lower doped region of lower doping than the shallow contact region.
- 4. A semiconductor device according to claim 3, wherein:

the source implantation includes a higher doped shallow source contact region and a lower doped source drift region between the higher doped source contact region and the body;

the drain implantation includes a higher doped shallow drain contact region and a lower doped drain drift region between the higher doped drain contact region and the body;

the insulated gate trench includes potential plate regions extending longitudinally on either side of a central region, the potential plate regions being adjacent to the source and drain drift regions respectively, and the central region being adjacent to the body; and

the thickness of the gate dielectric sidewalls of the insulated gate trench is greater in the potential plate regions of the insulated gate than the central region.

- 5. A semiconductor device according to claim 1 comprising a plurality of cells laterally spaced across the first major surface.
- 6. A semiconductor device according to claim 5 wherein gate trenches alternate with the plurality of cells laterally across the first major surface.
- 7. A semiconductor device according to claim 5 wherein each cell has a gate trench laterally within the confines of the cell.
- 8. A semiconductor device according to claim 3 wherein the lower doped region of lower doping than the shallow contact region extends vertically below the shallow contact region to a depth at least 80% of the depth of the trench.
- 9. A semiconductor device according to claim 1, wherein the source and drain implantations consist exclusively of the shallow contact region.
- 10. A semiconductor device according to claim 1 on a conductive substrate of first conductivity type.

APPENDIX OF EVIDENCE

Appellant is unaware of any evidence submitted in this application pursuant to 37 C.F.R. §§ 1.130, 1.131, and 1.132.

APPENDIX OF RELATED PROCEEDINGS

As stated in Section II above, Appellant is unaware of any related appeals, interferences or judicial proceedings.